

Description

The KGF65A3H, MGF65A3H, and FGF65A3H are 650 V Field Stop IGBTs. Sanken original trench structure decreases gate capacitance, and achieves high speed switching and switching loss reduction. Thus, these Field Stop IGBTs can improve the efficiency of your circuit.

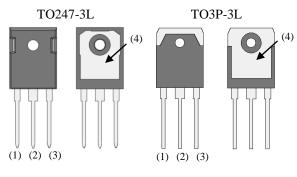
Features

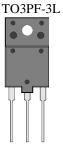
- Low Saturation Voltage
- High Speed Switching
- With Integrated Fast Recovery Diode
- RoHS Compliant
- V_{CE} ------ 650 V I_C (T_C = 100 °C)------ 30 A

Applications

- Welding Converters
- PFC Circuit

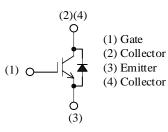
Packages







(1) (2) (3)



Not to scale

Selection Guide

Part Number	Package
KGF65A3H	TO247-3L
MGF65A3H	TO3P-3L
FGF65A3H	TO3PF-3L

Absolute Maximum Ratings

Parameter	Symbol	Conditions	Rating	Unit	Remarks
Collector to Emitter Voltage	V _{CE}		650	V	
Gate to Emitter Voltage	V _{GE}		±30	V	
Continuous Collector Current ⁽¹⁾	т	$T_C = 25 \ ^{\circ}C$	50	A	
Continuous Conector Current	I _C	$T_{\rm C} = 100 \ ^{\circ}{\rm C}$	30	Α	
Pulsed Collector Current	I _{C(PULSE)}	$PW \le 1 \text{ ms},$ duty cycle $\le 1\%$	90	А	
Diode Continuous Forward Current ⁽¹⁾	т	$T_C = 25 \ ^{\circ}C$	40 ⁽²⁾	A	
Diode Continuous Forward Current	I_{F}	$T_{\rm C} = 100 \ ^{\circ}{\rm C}$	30	A	
Diode Pulsed Forward Current	I _{F(PULSE)}	$PW \le 1 ms,$ duty cycle $\le 1\%$	90	А	
Short Circuit Withstand Time	t _{SC}		10	μs	
Power Dissipation	P _D	$T_{C} = 25 \ ^{\circ}C$	217	W	MGF65A3H KGF65A3H
I IIII			72		FGF65A3H
Operating Junction Temperature	T _J		175	°C	
Storage Temperature	T _{STG}		-55 to 150	°C	
Isolation Voltage	V _{ISO(RMS)}	Between surface of case and all pins that are shorted; AC, 60 Hz, 1 min	1500	v	FGF65A3H

Unless otherwise specified, $T_A = 25 \ ^{\circ}C$

Thermal Characteristics

Unless otherwise specified, $T_A = 25 \ ^\circ C$

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remarks
Thermal Resistance of IGBT	R _{0JC} (IGBT)		_	—	0.69	°C/W	MGF65A3H KGF65A3H
(Junction to Case)					2.08		FGF65A3H
Thermal Resistance of Diode					1.15		MGF65A3H
(Junction to Case)	$R_{\theta JC}(Di)$				1.15	°C/W	KGF65A3H
(Junction to Case)					2.28		FGF65A3H

⁽¹⁾ I_C and I_F are determined by the maximum junction temperature for TO3P-3L package. ⁽²⁾ Determined by bonding wires capability.

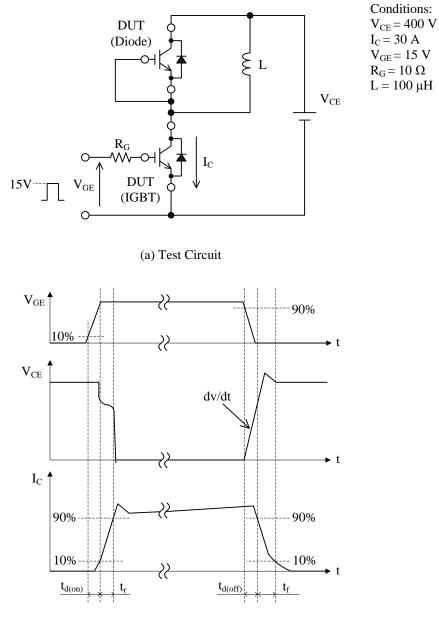
Electrical Characteristics

Unless	otherwise	specified	т.	- 25 °C	
Unicss	other wise	specifieu,	IA	-23 C	

Parameter $T_A = 25$ °C	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector to Emitter Breakdown Voltage	V _{(BR)CES}	$I_{C} = 100 \ \mu A, V_{GE} = 0 \ V$	650			V
Collector to Emitter Leakage Current	I _{CES}	$V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$	—		100	μΑ
Gate to Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30 \text{ V}$	—		±500	nA
Gate Threshold Voltage	V _{GE(TH)}	$V_{CE} = 10 \text{ V}, I_C = 1 \text{ mA}$	4.0	5.5	7.0	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	$V_{GE} = 15 \text{ V}, I_C = 30 \text{ A}$		1.9	2.37	V
Input Capacitance	C _{ies}	$V_{CE} = 20 V,$		1800		
Output Capacitance	C _{oes}	$V_{GE} = 0 V,$		200		pF
Reverse Transfer Capacitance	C _{res}	f = 1.0 MHz,	_	80	_	
Gate Charge	Q_{g}	$V_{CE} = 520 \text{ V}, I_C = 30 \text{ A},$ $V_{GE} = 15 \text{ V}$		60		nC
Turn-on Delay Time	t _{d(on)}			30		
Rise Time	t _r		_	30	_	
Turn-off Delay Time	$t_{d(off)}$	$T_{I} = 25 ^{\circ}C,$		90		ns
Fall Time	t _f	see Figure 1		30		
Turn-on Energy ⁽³⁾	Eon			0.5		. T
Turn-off Energy	E_{off}			0.4		mJ
Turn-on Delay Time	t _{d(on)}			30		
Rise Time	t _r			30		
Turn-off Delay Time	$t_{d(off)}$	$T_{J} = 175 \ ^{\circ}C,$		120		ns
Fall Time	t _f	see Figure 1		60		
Turn-on Energy ⁽³⁾	Eon]		1.0		T
Turn-off Energy	E_{off}	1		0.7		mJ
Emitter to Collector Diode Forward Voltage	$V_{\rm F}$	$I_F = 30 \text{ A}$		1.8		V
Emitter to Collector Diode Reverse Recovery Time	t _{rr}	$I_F = 30 \text{ A}, \\ di/dt = 700 \text{ A}/\mu\text{s}$		50		ns

⁽³⁾ Energy losses include the reverse recovery of diode.

Test Circuits and Waveforms



(b) Waveform

Figure 1. Test Circuits and Waveforms of dv/dt and Switching Time

Rating and Characteristic Curves

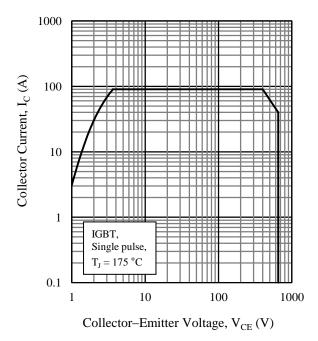


Figure 2. IGBT Reverse Bias Safe Operating Area

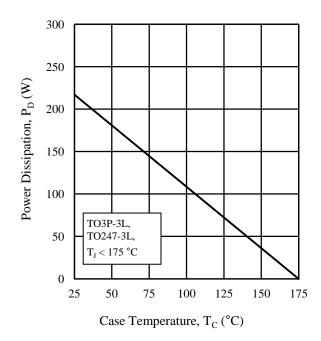


Figure 4. Power Dissipation vs. TO3P-3L and TO247-3L Case Temperature

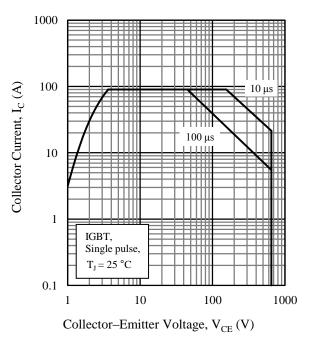


Figure 3. IGBT Safe Operating Area

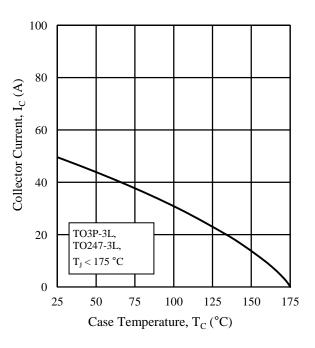


Figure 5. Collector Current vs. TO3P-3L and TO247-3L Case Temperature

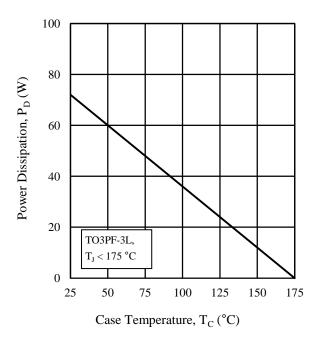


Figure 6. Power Dissipation vs. TO3PF-3L Case Temperature

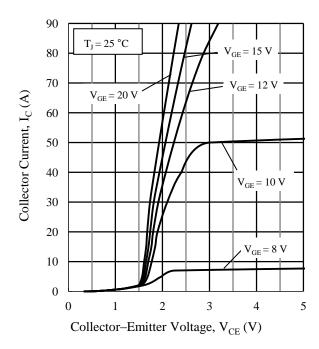


Figure 8. Output Characteristics ($T_J = 25 \ ^{\circ}C$)

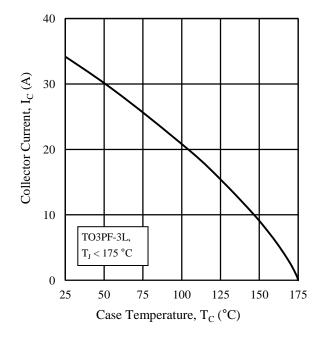


Figure 7. Collector Current vs. TO3PF-3L Case Temperature

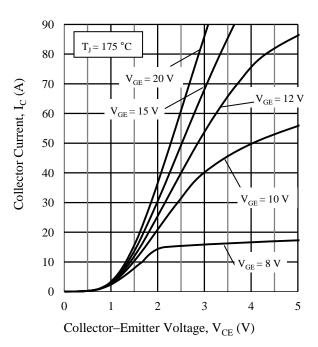


Figure 9. Output Characteristics ($T_J = 175 \ ^{\circ}C$)

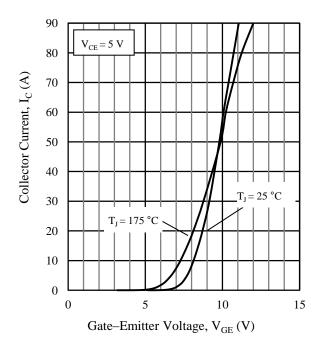


Figure 10. Transfer Characteristics

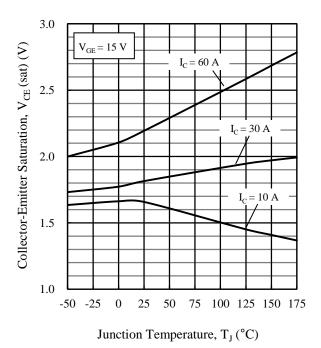


Figure 11. Saturation Voltage vs. Junction Temperature

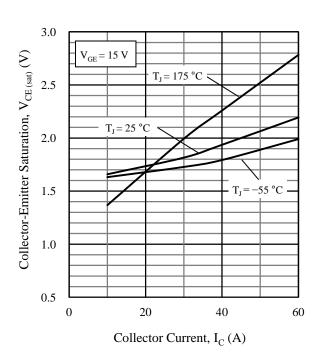


Figure 12. Saturation Voltage vs. Collector Current

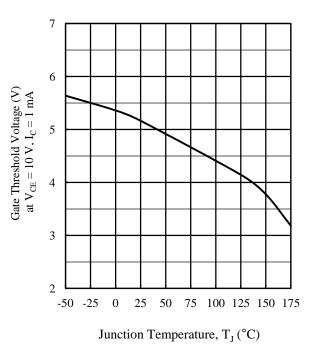
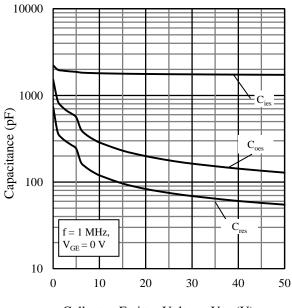


Figure 13. Gate Threshold Voltage vs. Junction Temperature



Collector–Emitter Voltage, V_{CE} (V)

Figure 14. Capacitance Characteristics

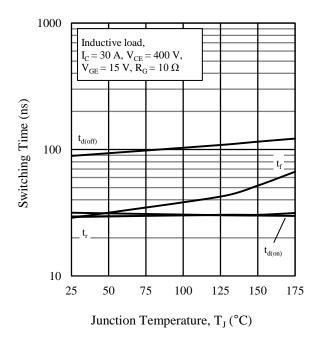


Figure 16. Switching Time vs. Junction Temperature

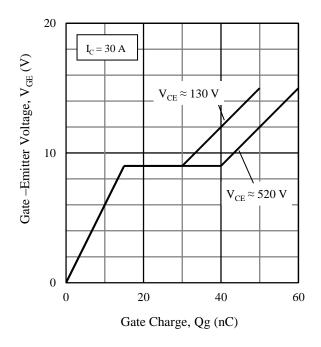


Figure 15. Typical Gate Charge

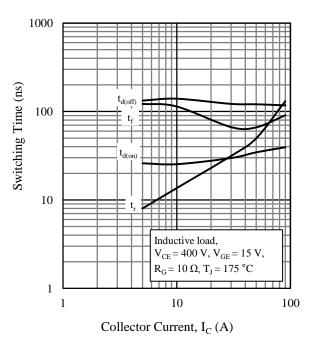


Figure 17. Switching Time vs. Collector Current

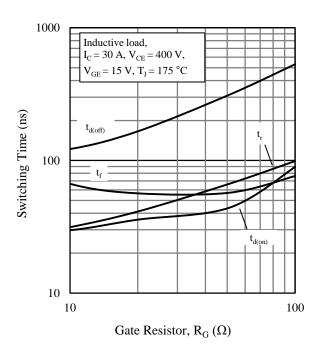


Figure 18. Switching Time vs. Gate Resistor

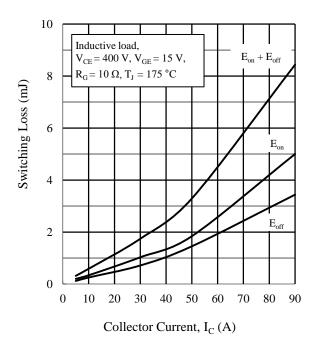


Figure 20. Switching Loss vs. Collector Current

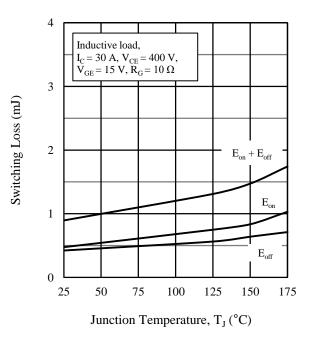


Figure 19. Switching Loss vs. Junction Temperature

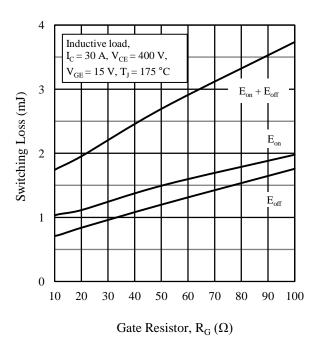
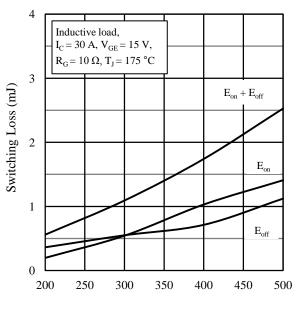


Figure 21. Switching Loss vs. Gate Resistor



Collector-Emitter Voltage, V_{CE} (V)

Figure 22. Switching Loss vs. Collector-Emitter Voltage

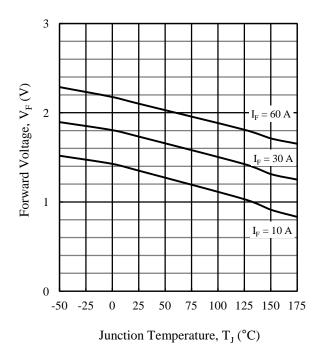
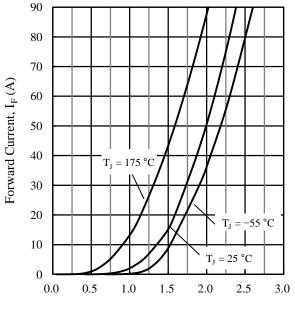


Figure 24. Diode Forward Voltage vs. Junction Temperature



Forward Voltage, V_F(V)

Figure 23. Diode Forward Characteristics

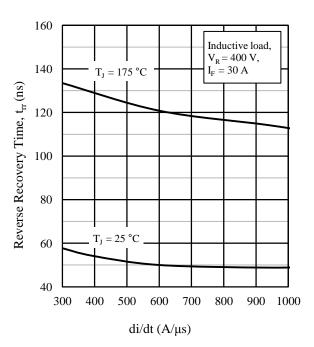
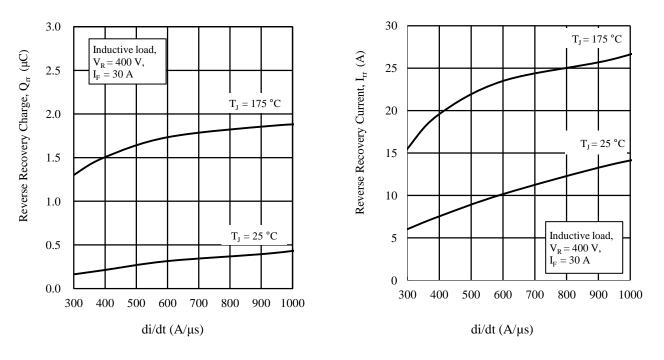


Figure 25. Diode Reverse Recovery Time vs. di/dt



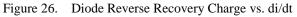


Figure 27. Diode Reverse Recovery Current vs. di/dt

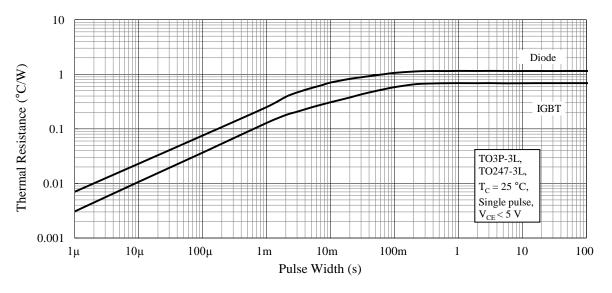


Figure 28. Transient Thermal Resistance (TO3P-3L and TO247-3L)

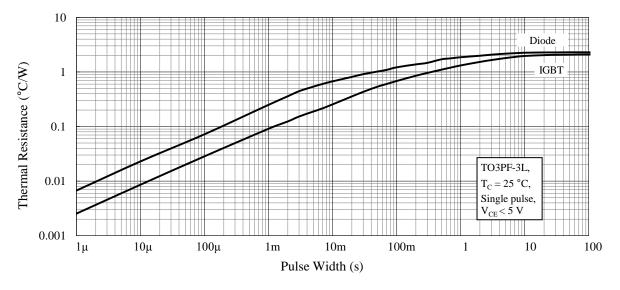
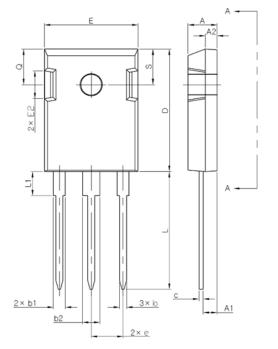
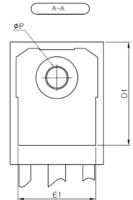


Figure 29. Transient Thermal Resistance (TO3PF-3L)

Physical Dimensions

• TO247-3L



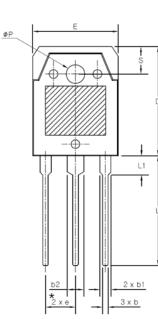


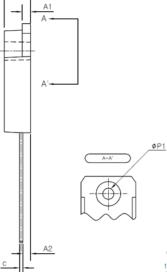
SYMBOL	MIN	NOM	MAX	
Α	4.83	5.02	5.21	
A1	2.29	2.41	2.54	
A2	1.91	2.04	2.16	
b	1.14	1.27	1.40	
b1	1.91	2.10	2.20	
b2	2.92	3.10	3.20	
С	0.61	0.71	0.80	
D	20.80	21.07	21.34	
D1	17.43	17.63	17.83	
E	15.75	15.94	16.13	
E1	13.06	13.26	13.46	
E2	4.32	4.58	4.83	
е	5.25	5.45	5.65	
L	19.81	20.19	20.57	
L1	3.81	4.07	4.32	
ØΡ	3.55	3.60	3.65	
Q	5.59	5.90	6.20	
S	6.15 BSC			

NOTE

1. THESE DIMENSION DO NOT INCLUDE MOLD PROTRUSION

• TO3P-3L



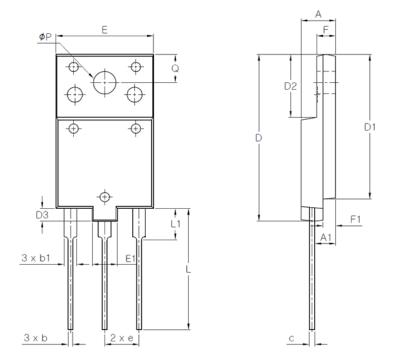


SYMBOL	MIN	NOM	MAX
А	4.60	4.80	5.00
A1	1.45	1.50	1.65
A2	1.20	1.40	1.60
b	0.80	1.00	1.20
b1	1.80	2.00	2.20
b2	2.80	3.00	3.20
с	0.55	0.60	0.75
D	19.70	19.90	20.10
E	15.40	15.60	15.80
* _e	5.25	5.45	5.65
L	19.80	20.00	20.20
L1	3.30	3.50	3.70
ØΡ	3.30	3.40	3.50
ØP1	3.10	3.20	3.30
S	4.80	5.00	5.20

NOTE

1. THESE DIMENSIONS DO NOT INCLUDE PROTRUSIONS OF THE MOLD. 2. THE "()" MARK IS THE REFERENCE

• TO3PF-3L

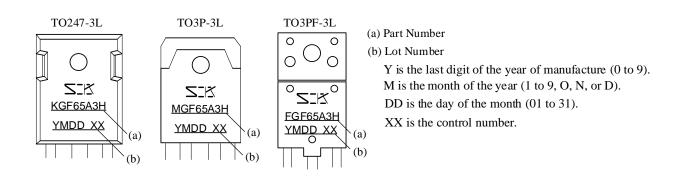


SYMBOL	MIN	NOM	MAX
А	5.30	5,50	5.70
A1	3.10	3,30	3,50
b	0.65	0,75	0.95
b1	1,80	2,00	2,20
С	0.80	0.90	1.10
D	26,30	26.50	26.70
D1	22.80	23.00	23.20
D2	9,80	10.00	10.20
D3	1.80	2.00	2.20
E	15.30	15.50	15.70
E1	3.80	4.00	4.20
е	5,25	5,45	5.65
F	2,80	3,00	3.20
F1	1.80	2.00	2.20
L	19.10	19.30	19.50
L1	4.80	5.00	5.20
Q	4,30	4,50	4.70
φP	3.40	3,60	3,80

NOTES:

- Dimensions in millimeters
- Bare lead frame TO247, TO3P and TO3PF: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:
 Flow: 260 ± 5 °C / 10 ± 1 s, 2 times
 Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the products.)
- Soldering should be at a distance of at least 1.5 mm from the body of the products.
- The recommended screw torque for TO247, TO3P and TO3PF: 0.686 N·m to 0.882 N·m (7 kgf·cm to 9 kgf·cm)

Marking Diagram



Important Notes

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- No anti-radioactive ray design has been adopted for the Sanken Products.
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